

Flyback method
Isolated Output Power 48W
BD28C57HFJ-EVK-001

<High Voltage Safety Precautions>

◇ Read all safety precautions before use

Please note that this document covers only the **BD28C57HFJ** evaluation board (**BD28C57HFJ-EVK-001**) and its functions. For additional information, please refer to the datasheet.

To ensure safe operation, please carefully read all precautions before handling the evaluation board



Depending on the configuration of the board and voltages used,

Potentially lethal voltages may be generated.

Therefore, please make sure to read and observe all safety precautions described in the red box below.

Before Use

- [1] Verify that the parts/components are not damaged or missing (i.e. due to the drops).
- [2] Check that there are no conductive foreign objects on the board.
- [3] Be careful when performing soldering on the module and/or evaluation board to ensure that solder splash does not occur.
- [4] Check that there is no condensation or water droplets on the circuit board.

During Use

- [5] Be careful to not allow conductive objects to come into contact with the board.
- [6] **Brief accidental contact or even bringing your hand close to the board may result in discharge and lead to severe injury or death.**

Therefore, DO NOT touch the board with your bare hands or bring them too close to the board.

In addition, as mentioned above please exercise extreme caution when using conductive tools such as tweezers and screwdrivers.

- [7] If used under conditions beyond its rated voltage, it may cause defects such as short-circuit or, depending on the circumstances, explosion or other permanent damages.
- [8] Be sure to wear insulated gloves when handling is required during operation.

After Use

- [9] The ROHM Evaluation Board contains the circuits which store the high voltage. Since it stores the charges even after the connected power circuits are cut, please discharge the electricity after using it, and please deal with it after confirming such electric discharge.
- [10] Protect against electric shocks by wearing insulated gloves when handling.

This evaluation board is intended for use only in research and development facilities and should be handled **only by qualified personnel familiar with all safety and operating procedures.**

We recommend carrying out operation in a safe environment that includes the use of high voltage signage at all entrances, safety interlocks, and protective glasses.

AC/DC Converter

Flyback method Isolated 48 W 24 V 2 A BD28C57HFJ Evaluation Board BD28C57HFJ-EVK-001

General Description

This evaluation board outputs an isolated voltage of 24 V from an input of 300 VDC to 900 VDC, and the maximum output current is 2 A.

A SiC MOSFET (SCT12H12NZ) with 1700 V, $R_{dsON} = 1.1 \Omega$ typ is used so that an input voltage of up to 900 VDC can be applied. The control IC used is the BD28C57HFJ, which is suitable for driving SiC MOSFET.

The control method is current mode. The oscillation frequency is approximately 65 kHz, and the duty max is 50%.

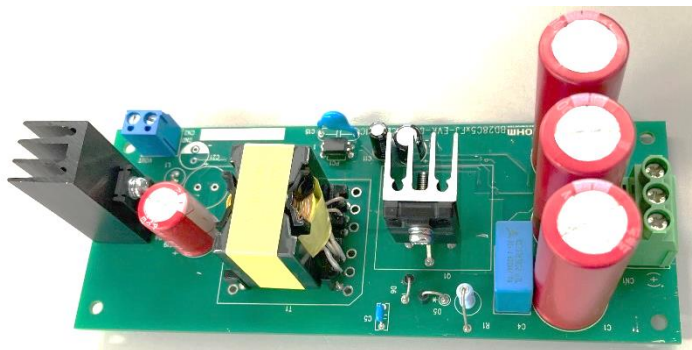


Figure 1. BD28C57HFJ-EVK-001

Performance Specification

Electrical characteristic

Not guarantee the characteristics is representative value.

Unless otherwise specified $V_{IN} = 400V_{DC}$, $I_{OUT} = 2 A$, $T_a = 25 ^\circ C$

Parameter	Symbol	Min	Typ	Max	Units	Conditions
Input Voltage Range	V_{IN}	300	400	900	V	
Input Frequency	f_{LINE}	47	-	63	Hz	
Output Voltage	V_{OUT}	22.6	24.0	25.2	V	
Output Current Range ^(Note 1)	I_{OUT1}	0	-	2.0	A	
Maximum Output Power ^(Note 1)	P_{OUT}			48	W	
Standby Input Power	P_{INSTBY}	-	0.67	-	W	$I_{OUT} = 0 A$ $V_{IN} = 230V$
Power supply efficiency	η	86	89.0	-	%	
Output Ripple Voltage ^(Note 2)	V_{ripple}	-	0.21	0.48	Vpp	
Operating Temperature		-10	+25	+60	$^\circ C$	

(Note 1) Adjust the operating time so that surface temperature of no component exceeds $105 ^\circ C$

(Note 2) Do not consider spike noise

Derating

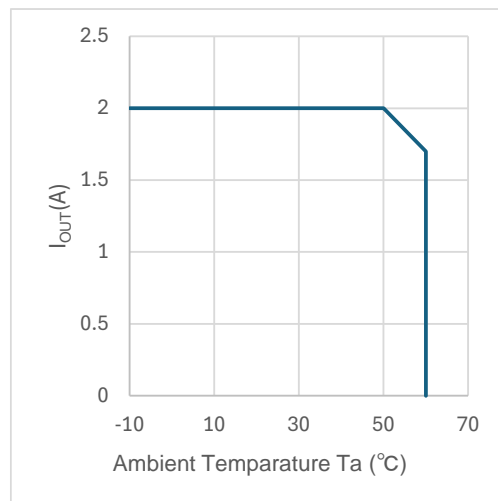


Figure 2. Temperature derating curve

Operation Procedure

1 Necessary Equipment

- (1) DC power supply (90 VDC to 1 k VDC, 200 W or more)
- (2) Load equipment (3 A at maximum value)
- (3) DC voltmeter

2 Connect to Each Equipment

- (1) Preset the AC power to 90 Vac to 264 Vac and turn off the power output.
- (2) Set the load below the rated current of each output to disable the load.
- (3) Connect the N terminal of the power supply to the CN1-1: AC (N) terminal and the L terminal to the CN1-2: AC (L) terminal with a pair of wires.
- (4) Connect load to VOUT terminal from the positive terminal and to GND terminal with a pair of wires.
- (5) When connecting a power meter, connect as follows. (For details, refer to the User's Manual of the electricity meter you are using.)
- (6) Connect the positive terminal of the DC voltmeter to VOUT terminal and the negative terminal to GND terminal for output voltage measurement.
- (7) DC power supply switch is ON.
- (8) Make sure that the DC voltmeter reading is at the set voltage (24 V).
- (9) Electronic load switch is ON.

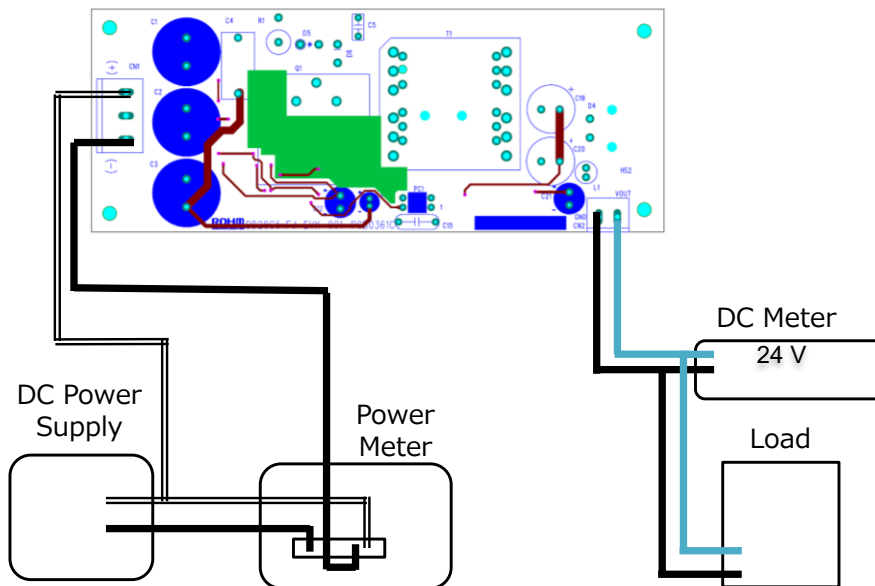


Figure 3. Diagram of How to Connect

Application Circuit

This evaluation board uses a flyback type PWM method. The oscillation frequency is set to approximately 65kHz.

The output (24V) voltage is monitored by a feedback circuit and fed back to the COM terminal of the BD28C57HFJ through a photocoupler.

At startup, the VDD terminal voltage rises as a result of the voltage being supplied to the VDD terminal through the startup circuit (Q5, Q6).

When the VDD terminal voltage exceeds the UVLO release voltage of 18.8V (Typ), the BD28C57HFJ starts operating.

When operation starts, 5V is output from the VREF terminal. This voltage turns Q8 ON, Q6 OFF, and the supply from Q6 is cut off, contributing to reducing standby power.

The oscillation frequency is determined by R21 (12kΩ) and C9 (1000pF). It is set to approximately 65kHz.

A leading edge blanking circuit is installed to prevent malfunction due to noise.

The leading edge blanking circuit consists of Q2, R27, C14, and R28.

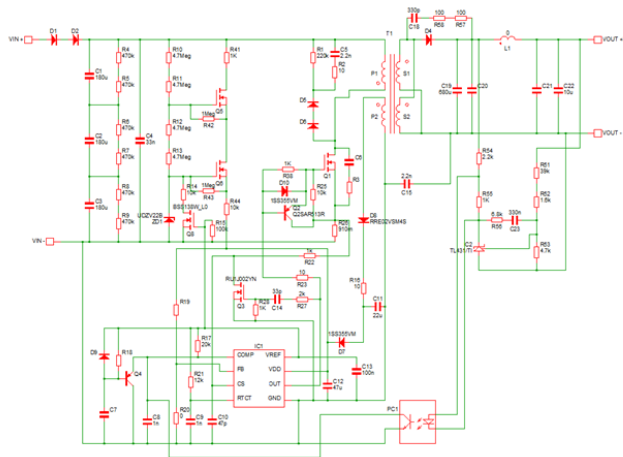


Figure 4. Application Circuit

BD28C57HFJ General Description

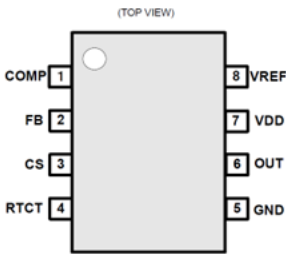
Features

- PWM Type Current Mode Control
- Low power consumption
- UVLO function for VDD pin
- Overcurrent protection circuit for each cycle
- Switching frequency setting pin

Key Specifications

- Operating Power Supply Voltage Range 6.90 V to 28.00 V
- Circuit Current 2.0 mA (Max.)
- Starting Current : 60 μA (Typ)
- Operating Temperature Range -40°C to +125 °C

Pin Configuration



Package

SOP-J8

W (Typ) x D (Typ) x H (Max)

4.9 mm x 8.0 mm x 1.65 mm

Pitch: 1.27 mm (Typ)



Figure 5. Pin Configuration

Pin Descriptions

Table 1. BD28C57HFJ Pin Configuration

Pin No.	Pin Name	I/O	Function
1	COMP	O	Error amplifier output pin
2	FB	I	Feedback signal output pin
3	CS	I	Primary side current sense pin
4	RTCT	I/O	Switching frequency setting pin
5	GND	-	GND pin
6	OUT	O	External MOS drive terminal pin
7	VDD	I	Power supply input pin
8	VREF	V	5V Output pin

Measurement Data

1 Load Regulation

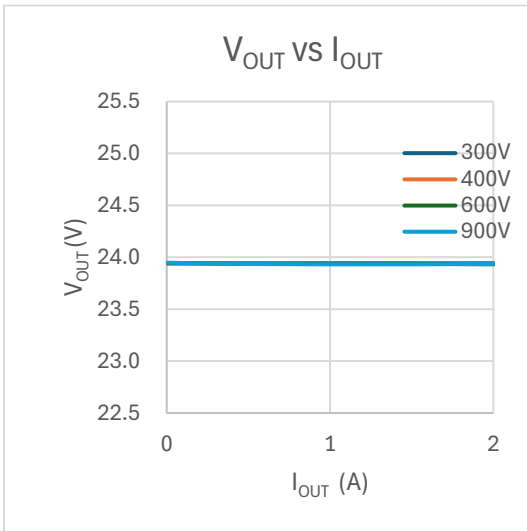


Figure 6. Load Regulation (V_{OUT} vs I_{OUT})

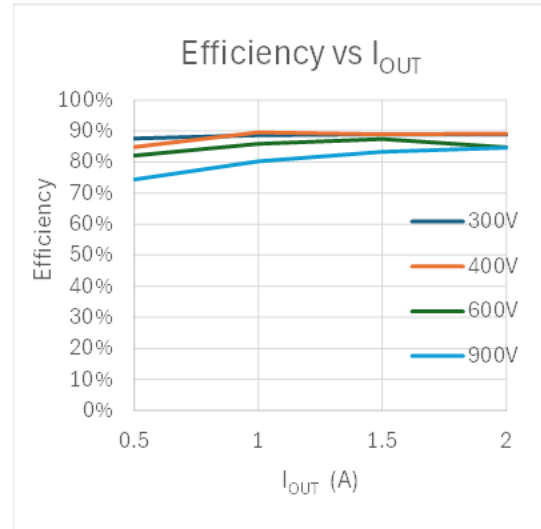


Figure 7. Efficiency vs I_{OUT}

2. Line Regulation

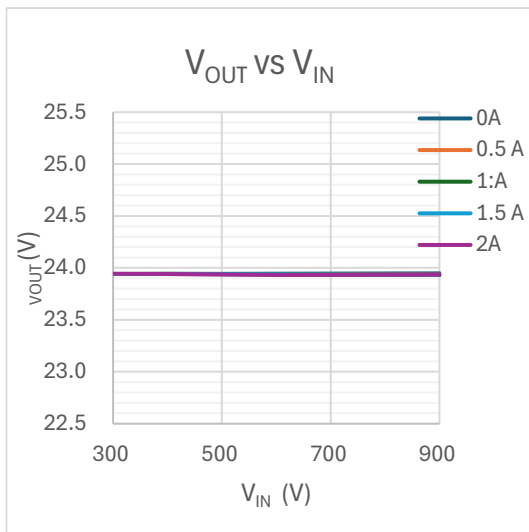


Figure 8. Line Regulation (V_{OUT} vs V_{IN})

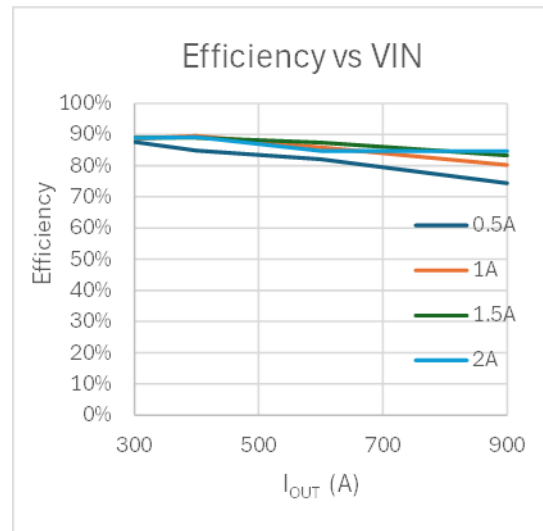


Figure 9. Efficiency vs Input Voltage

Measurement Data – continued

3 Switching Frequency

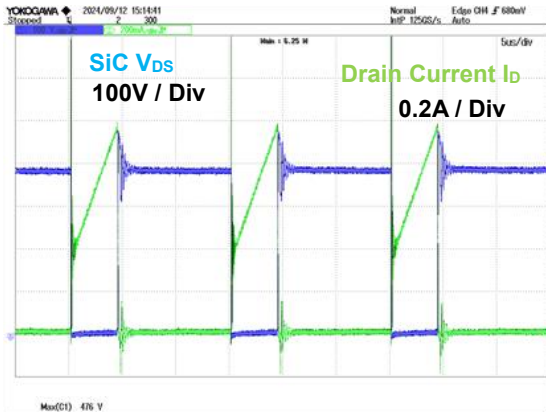


Figure 10. VDS, ID $V_{IN}=300\text{ VDC}, I_{OUT}=2\text{ A}$

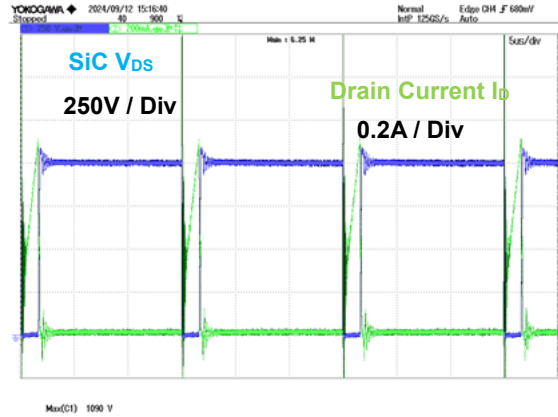


Figure11. VDS, ID $V_{IN}=900\text{ VDC}, I_{OUT}=2\text{ A}$

4 Switching Wave Form

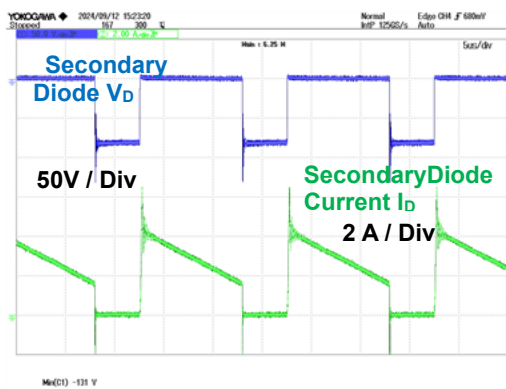


Figure 12. Secondary Diode at $V_{IN}=300\text{ VDC}, I_{OUT}=2.0\text{ A}$

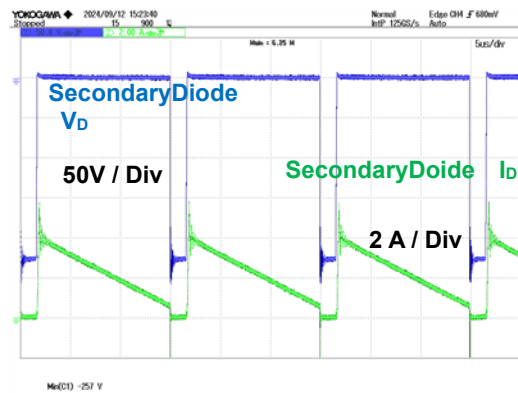


Figure 13. Secondary Diode at $V_{IN}=900\text{ VDC}, I_{OUT}=2.0\text{ A}$

Measurement Data - continued

4 Output current waveform during short circuit

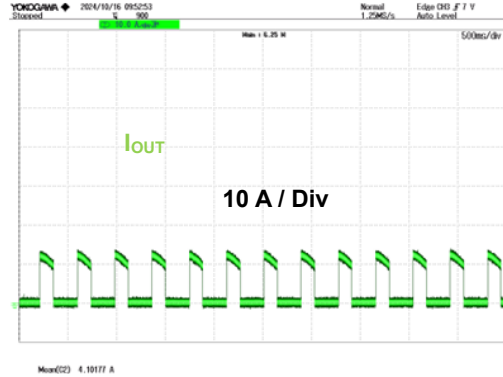
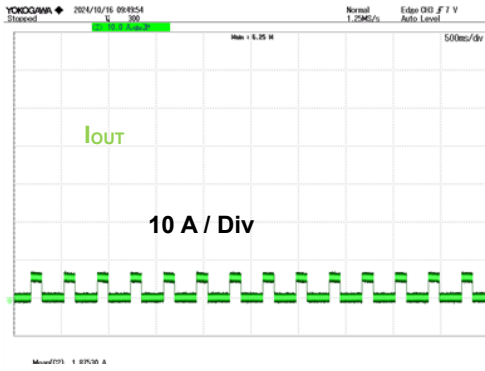


Figure 14. Output waveform during short circuit $V_{IN} = 300$ Vdc Figure 15. Output waveform during short circuit $V_{IN} = 900$ Vdc

Measurement Data - continued

5 Startup Wave Form

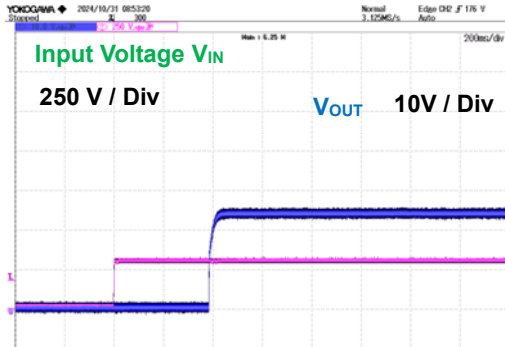


Figure 16. $V_{IN} = 300 \text{ VDC}$, $I_{OUT} = 0 \text{ A}$

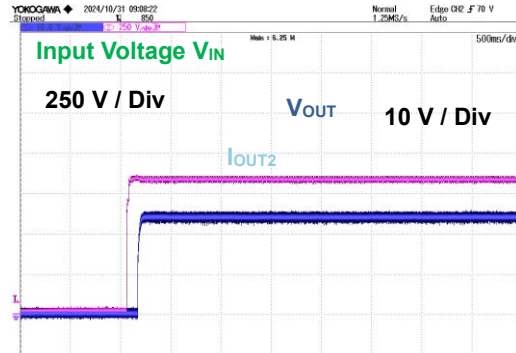


Figure 17. $V_{IN} = 900 \text{ VDC}$, $I_{OUT} = 0 \text{ A}$

6 Dynamic Load Fluctuation

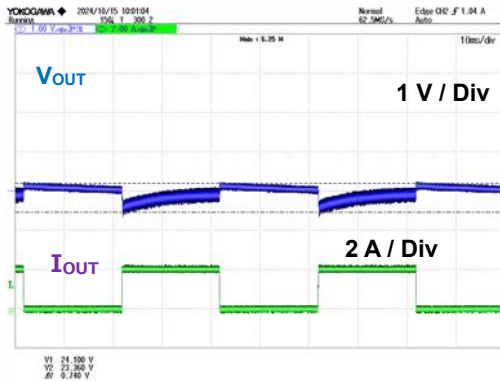


Figure 18. $V_{IN} = 930 \text{ VDC}$, $I_{OUT} = \text{switch } 0 \text{ A} / 2.0 \text{ A}$

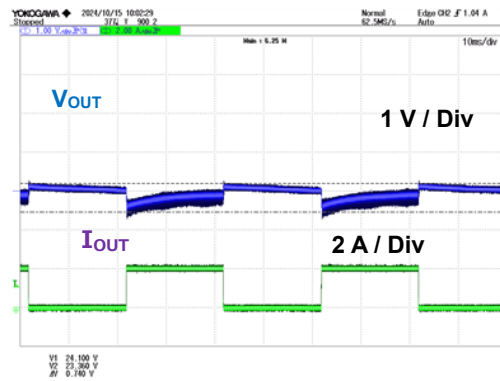


Figure 19. $V_{IN} = 900 \text{ VDC}$, $I_{OUT} = \text{switch } 0 \text{ A} / 2 \text{ A}$

Measurement Data - continued

7 Output Voltage Ripple Wave Form

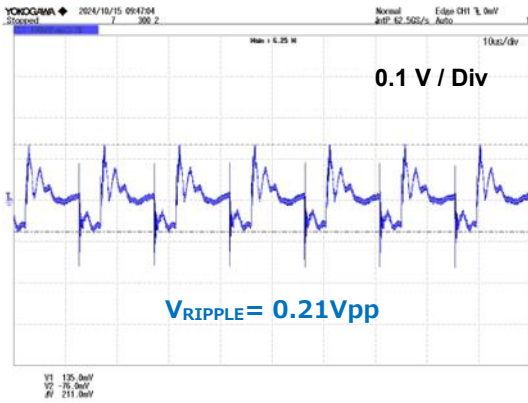


Figure 20. $V_{IN} = 300$ VDC, $I_{OUT} = 2.0$ A

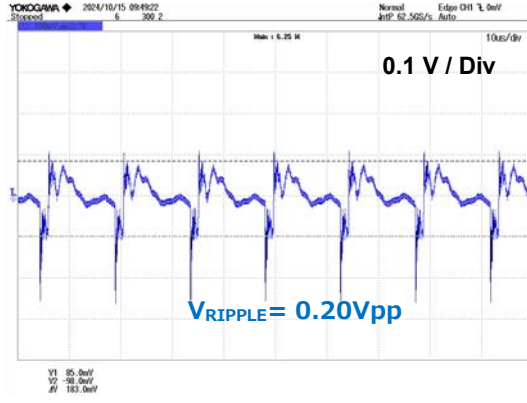


Figure 21. $V_{IN} = 900$ VDC, $I_{OUT} = 2.0$ A

8 Temperature of Parts Surface

They are measured after 20 minutes from applying a power supply.

VIN(VDC)	IOUT(A)	Q1(°C)	T1(°C)	D4(°C)
300	2	48.7	64.0	65.4
600	2	61.0	71.1	66.0
900	2	80.2	91.3	71.7

Table 2. Surface Temperature of Parts ($T_a = 24.8$ °C)

Schematics

$V_{IN} = 300 \text{ VDC} \sim 900 \text{ VDC}$, $V_{OUT} = 24 \text{ V } 2.0 \text{ A}$

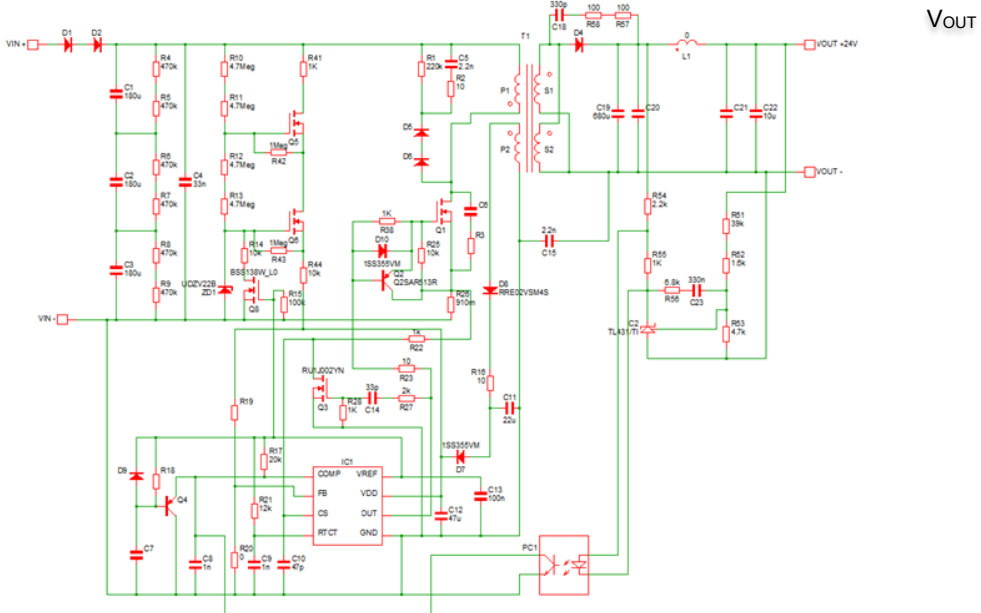


Figure 22. BD28C57HFJ-EVK-001 Schematics

Parts List

Table 3. BoM of BD28C54HFJ-EVK-001

Item	Value	Parts name	Manufacture
C1,C2,C3	180 μ F	8600021382024	Wuerth Electronik
C4	33 nF	B32672L1333J	TDK
C5	2200 pF	RDER73A222K2K1H03B	Murata
C6,C7,C20,C21,C24,C29,C30	-	Non-Maunted	
C 8 ,C9	1000 pF	HMK107B7102KA-T	Taiyo Yuden
C10	47 pF	GRM1885C2E470JW07	Murata
C11	22 μ F	UHD1H220MDD	Nichicon
C12	47 μ F	7075764	RS PRO
C13	0.1 μ F	HMK107B7104MA-T	Taiyo Yuden
C14	33 pF	GCM1880C1H330GA01	Murata
C15	2200 pF	DE1E3RA222MJ4BP01F	Murata
C18	330 pF/1kV	GRM31A7U3A331JW31D	Murata
C19	680 μ F/35V	860080578019	
C22	10 μ F	GRM31CD71H106KE11	Murata
C23	0.33 μ F	GCM188R71C334KA37D	Taiyo Yuden
CN1	-	691250610003	Wuerth Electronik
CN2	-	691101710002	Wuerth Electronik
D1,D2	1 A	BYG23T-M3	VISHAY
D4	20 A	RFUH25TB3SNZ	Rohm
D5,D6	1 A	UF4007	On Semiconductor
D7,D10	0.1 A	1SS355VM	Rohm
D8	0.2 A	RRE02VSM4S	Rohm
HS1	22.9 kW	IC-1625-STL	Sankyo Thrmotech
HS2	14 kW	E2A-T220-38E	OHMITE
IC1		BD28C57HFJ-LB	ROHM
IC2		TL431BIDBZT	TI
L3		short	
PC1		LTV-817-B	LiteOn
Q1	3.7 A	SCT2H12NZ	Rohm
Q2	1 A	2SAR513RTL	Rohm
Q3	A	BSS138WT106	Rohm
Q5,Q6	21 mA	BSS126H6906XTSA1	Infineon
Q7	0.2 A	RU1C001UN	Rohm
R1	100 k Ω	ERG-2SJ104	
R2	10 Ω	ESR25JZPJ100	Rohm
R3,R18,R19,R30,R59,Q4	-	Ω	Non-Maunted
R4,R5,R6,R7,R8,R9	470 k Ω	KTR18EZPJ474	Rohm
R10,R11,R12,R13	4.7 M Ω	KTR18EZPJ475	Rohm
R14,R25	10 k Ω	MCR03EZPFX1002	Rohm
R15	100 k Ω	MCR03EZPJ104	Rohm
R16,R23	10 Ω	MCR18EZPJ100	Rohm
R17	20 k Ω	MCR03EZPFX2002	Rohm
R20	0 k Ω	MCR03EZPJ000	Rohm
R21	12 k Ω	MCR03EZPFX1202	Rohm
R22	1 k Ω	MCR18EZPJ102	Rohm
R24,R28,R55	1 k Ω	MCR03EZPFX1001	Rohm
R26	0.91 Ω	LTR100PZPZFLR910	Rohm
R27	2 k Ω	MCR03EZPFX2001	Rohm
R41	1 k Ω	KTR18EZPJ102	Rohm
R42,R43	1 M Ω	MCR03EZPJ105	Rohm
R44	10 k Ω	MCR18EZPJ103	Rohm
R51	39 k Ω	MCR03EZPFX3902	Rohm
R52	1.6 k Ω	MCR03EZPFX1601	Rohm
R53	4.7 k Ω	MCR03EZPFX4701	Rohm
R54	2.2 k Ω	MCR03EZPFX2201	Rohm
R56	6.8 k Ω	MCR03EZPJ682	Rohm
R57,R58	100 Ω	ESR25JZPZJ101	Rohm
T1	1.66 mH	XE2870YA	Alpa Trans
ZD1	22 V	UDZVTE1722B	Rohm

Materials may be changed without notifying.

Layout

Size: 155 mm x 60 mm

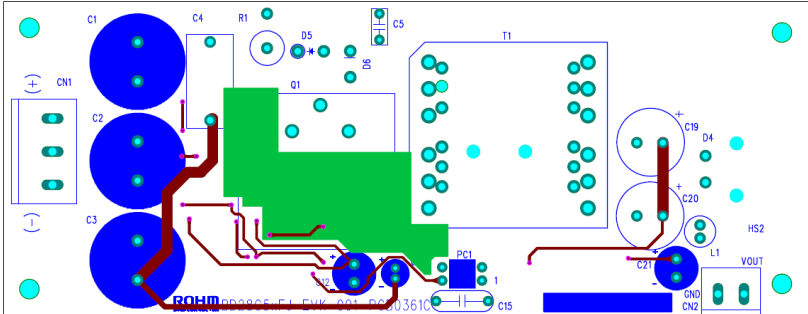


Figure 23. TOP Silkscreen (Top view)

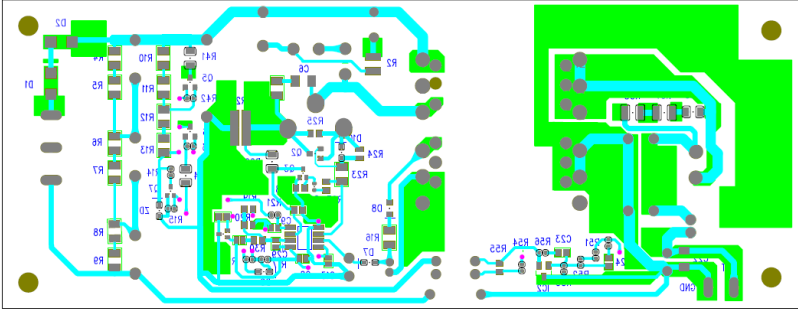


Figure 24. Bottom Layout (Top View)

Specification of the Transformer

Manufacture Alphatrans Co., Ltd. (1-7-2, Bakurou-cho, Chuo-ku, Osaka City, 541-0059, Japan)
<http://www.alphatrans.jp/>

Product Name: XE2870Y_A
 Bobbin: PQ2625-4
 Core: PQ2625

- Primary Inductance: 1.866mH± 10 %
(100 kHz, 1 V)
- Withstand Voltage
 - Between Primary and Secondary : AC1500 V
 - Between Primary and Core: AC1500 V
 - Between Secondary and Core: AC500 V
- Insulation Resistance 100 MΩ or more (DC500 V)

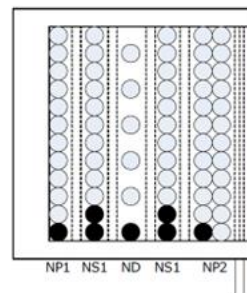
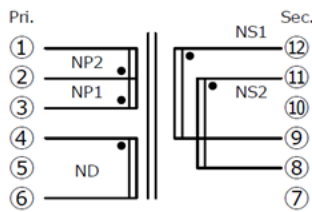


Figure 25. Circuit Diagram

Figure 26. Structure Diagram

Table 4. Product Specification of XE2870Y_B

No.	Transformer	Winding Pin		Wire	Turn Number	Tape Layer	Wire Specification
		Start	Finish				
1	NP1	3	2	TEX-E / Φ0.30	25	2	COMPACT
2	NS1	12	9	2UEW / Φ0.35	17	2	COMPACT
3	ND	4	6	TEX-E / Φ0.20	15	2	COMPACT
4	NS1	11	8	2UEW / Φ0.35	17	2	COMPACT
5	NP2	2	1	TEX-E / Φ0.30	50	3	COMPACT

Revision History

Date	Rev.	Changes
12.November.2024	001	New Release

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